



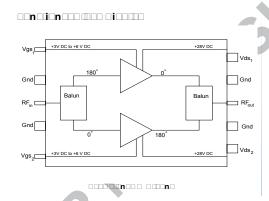
# 4WATT DISCRETE LDMOS FET IN CERAMIC PACKAGE

BLD1083CZ TE0105 RFMD Green, RoHS Compliant, Pb-Free Package: RF083

# **Product Description**

RFMD's SLD-1083CZ is a robust 4 Watt high performance LDMOS transistor designed for operation to 1600 MHz, It is an excellent solution for applications requiring high linearity and efficiency at a low cost. The SLD-1083CZ is typically used in the design of driver stages for power amplifiers, repeaters, and RFID applications. The power transistor is fabricated using RFMD's latest, high performance LDMOS II process.

# Optimum Technology Matching® Applied GaAs HBT GaAs MESFET InGaP HBT SiGe BiCMOS Si BiCMOS SiGe HBT GaAs pHEMT Si CMOS Si BJT GaN HEMT InP HBT RF MEMS ✓ LDMOS



## **Features**

- 4Watt Output P<sub>1dB</sub>
- Single Polarity Supply Voltage
- High Gain; 18dB at 915MHz
- High Efficiency: 43% at 3W CW
- XeMOS II LDMOS
- Integrated ED Protection, Class 1B

# **Applications**

- Base Station PA Driver
- Repeaters
- RFID
- Military Communication
- GSM/CDMA

Parameter	Specification			Unit	Condition	
Farameter	Min.	Тур.	Max.	UIIIL	Condition	
RF Specifications					V <sub>DS</sub> =28.0V, I <sub>DQ</sub> =50mA, T <sub>FLANGE</sub> =25°C	
Frequency of Operation			1600	MHz		
Gain	18	19		dB	3Watt CW, 902MHz to 928MHz	
Drain Efficiency	40	43		%	3Watt CW, 915MHz	
Input Return Loss	-9.5	-12		dB	3Watt output Power, 915MHz	
Third Order IMD		-30	-26	dBc	3Watt PEP (Two Tone), 915MHz	
1dB Compression		4		Watt	915MHz	
IS-95, 9 Ch Fwd, Offset=750KHz		21		dBm	ACPR Integrated Bandwidth, ACPR=-55dB	
		29		dBm	ACPR Integrated Bandwidth, ACPR=-45dB	
Thermal Resistance (Junction - Case)		11		°C/W		
DC Specifications						
Forward Transconductance		150		mA/V		
V <sub>GS</sub> Threshold		4.2		Volts	I <sub>DS</sub> =3mA, V <sub>DS</sub> =28V	
V <sub>GS</sub> Quiescent		4.2		Volts	I <sub>DS</sub> =50mA, V <sub>DS</sub> =28V	
V <sub>DS</sub> Breakdown		65		Volts	1mA V <sub>DS</sub> current	
Input Capacitance (Gate to Source)		5.2		pF	V <sub>GS</sub> =0V, V <sub>DS</sub> =28V	
Reverse Capacitance (Gate to Drain)		0.2		pF	V <sub>GS</sub> =0V, V <sub>DS</sub> =28V	
Output Capacitance (Drain to Source)		3.2		pF	V <sub>GS</sub> =0V, V <sub>DS</sub> =28V	
Drain to Source Resistance		3.0		Ω	V <sub>GS</sub> =10V, V <sub>DS</sub> =250mV	



## **Absolute Maximum Ratings**

Parameter	Rating	Unit
Drain Voltage (V <sub>DS</sub> )	35	V
Gate Voltage (V <sub>GS</sub> )	20	V
RF Input Power	+30	dBm
Load Impedance for Continuous Operation Without Damage	10:1	VSWR
Output Device Channel Temperature	+200	°C
Lead Temperature During Solder Reflow	+270	°C
Operating Temperature Range	-40 to +90	°C
Storage Temperature Range	-40 to +100	°C
ESD Rating - Human Body Model	750	V
MTTF - 85°C Leadframe, 200°C Channel	1.2×10 <sup>6</sup>	Hours

Operation of this device beyond any one of these limits may cause permanent damage. For reliable continuous operation, the device voltage and current must not exceed the maximum operating values specified in the table on page one.

# **A**

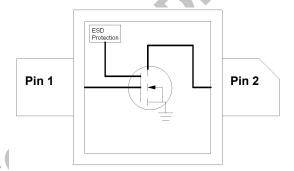
Caution! ESD sensitive device.

Exceeding any one or a combination of the Absolute Maximum Rating conditions may cause permanent damage to the device. Extended application of Absolute Maximum Rating conditions to the device may reduce device reliability. Specified typical performance or functional operation of the device under Absolute Maximum Rating conditions is not implied.

RoHS status based on EUDirective 2002/95/EC (at time of this document revision).

The information in this publication is believed to be accurate and reliable. However, no responsibility is assumed by RF Micro Devices, Inc. ("RFMD") for its use, nor for any infringement of patents, or other rights of third parties, resulting from its use. No license is granted by implication or otherwise under any patent or patent rights of RFMD. RFMD reserves the right to change component circuitry, recommended application circuitry and specifications at any time without prior notice.

### Pin Diagram



Case Flange = Ground

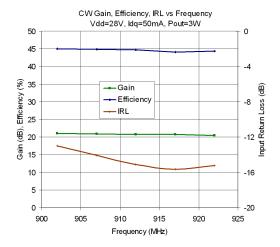
Note 1: Gate voltage must be applied to  $V_{GS}$  lead concurrently or after application of drain voltage to prevent potentially destructive oscillations. Bias voltages should never be applied to the transistor unless it is properly terminated on both input and output.

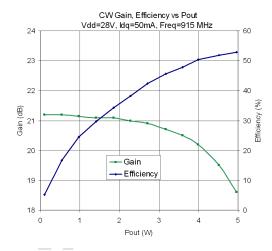
Note 2: The required  $V_{GS}$  corresponding to a specific  $I_{DQ}$  will vary from device to device due to the normal die-to-die variation in threshold voltage with LDMOS transistors.

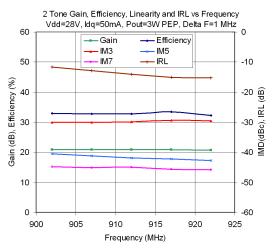
Note 3: The threshold voltage (V<sub>GSTH</sub>) of LDMOS transistors varies with device temperature. External temperature compensation may be required.

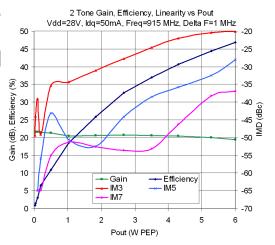


# Typical Performance Curves in 90 MHz Application Circuit





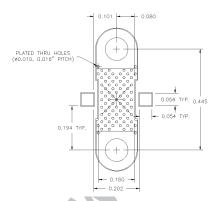






Pin	Function	Description
1	Gate	Transistor RF input and gate bias voltage. The gate bias voltage must be temperature compensated to maintain constant bias current over the operating temperature range. Care must be taken to protect against video transient that excedd the maximum input power or voltage.
2	Drain	Transistor RF output and drain bias voltage. Typical voltage 28V.
Flange	Source, GND	Exposed area on the bottom side of the package needs to be mechanically attatched to the ground plane of the board for optimum thermal and RF performance. See mounting instructions for recommendation.

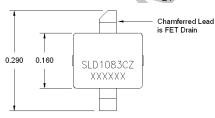
# **Suggested Pad Layout**



# **Package Drawing**

Dimensions in inches

Refer to drawing posted at www.rfmd.com for tolerances.



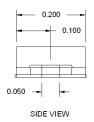
Lead Coplanarity
Lead foot to backside
0.000 ± 0.002

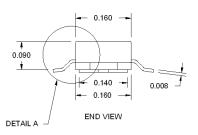
0.000±0.002

R0.015

DETAIL A

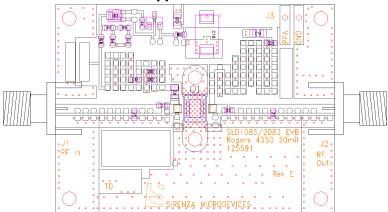
TOP VIEW







# 90 MHz Application Circuit



Reference	Description	Mfg	Mfg Part Number
Description			
C1	CAP 68 pF 250 V 5% 0603	ATC	600S680JT250XT
C2	CAP 18 pF 250 V 2% 0604	ATC	600S180GT250XT
L1	IND, 16nH 5% 0603	Coilcraft	0603CS-160XJB
L2	IND, 9.5 nH 5% nH 0603	Coilcraft	0603CS-9N5XJB
C10	CAP 0.1UF 16V 10% 0603	AVX	0603YG104ZA2A
C11, C20	CAP 1000 pF 50V 10% 603	AVX	06035C102KAT2A
C12	CAP 68 pF 250 V 5% 603	ATC	600S680JT250XT
C18	CAP 10uF 35V 20% TAN T ELECT	Kemet	T494D106M035AS
C19, C22	CAP 0.1 uF 50 V 10% 805	Panasonic	ECJ2YB1H104K
J1, J2	Connector SMA END 0.037	Johnson	142-0751-821
J3	Connector MTA SMD R/A 2 PIN	Amp	640455-2
R1	RES 324 1/16W 1% 603	Panasonic	ERJ-3EKF3240V
R2	RES 0Ω jumper 805	Panasonic	ERJ6GEY0R00V
R3	POT TRIM 500Ω 2MM	Panasonic	EVM-2WSX80B52
R30	RES 49.9 1/16W 1% 603	Panasonic	ERJ-EKF49R9V
R5	RES 130 1/16 W 1% 603	Panasonic	ERJ-3EKF1300V
R7	RES 210 1/16W 1% 603	Phillips	9C06031A2100FKHFT
R9	RES 0 1/16W 5% 603	Panasonic	ERJ-3GSY0R00V
R90	RES 1.0K 1/16W 1% 603	Panasonic	ERJ-3EKF1001V
RT1	THERMISTOR 100K 5% 603	Panasonic	ERT-J1VV104J
U1	IC VOLT REG 100MA 5V SOT-23	National	LM3480IM3-5.0
6 screws	SCREW #2-56 PHILIPS PAN HEAD	various	-
6 washers WASHER #2 FLAT SS		various	-
PCB PCB, 30 mils thick DK = 3.48		Rogers	4350
Heatsink	machined aluminum	various	-

**Ordering Information** 

Part Number	Reel Size	Devices/Reel	
SLD-1083CZ	7"	500	



